

JB1270-XFP-LC.S40

Tx: 1270nm/Rx: 1330nm BIDI XFP Transceiver for 10GbE/10FC RoHS 6 Compliant

Features

- Supports 9.95Gb/s to 11.3Gb/s data rates
- Power budget 16dB at least
- 1270nm DFB Transmitter/ 1330nm Receiver
- LC Connector
- ♦ +3.3V power supply only
- Power dissipation <2W
- Built-in digital diagnostic functions
- ◆ Case temperature range:
 Standard: 0~+70 ℃
- Complaint with XFP MSA
- ◆ Complaint with IEEE 802.3ae 10GBASE-ER/EW
- Complaint with 10GFC 1200-SM-LL-L



Applications

10GBASE-ER 10G Ethernet at

10.3125Gbps

- ◆ 10GBASE-EW 10G Ethernet at 9.953Gbps
- 1200-SM-LL-L 10G Fiber Channel at 10.51875Gbps

Ordering information

Part No.	Data Rate	Laser	Temp.	Power budget	Optical Interface	DDMI
JB1270-XFP-LC.S40*Note1	Up to 11.3Gbps	1270nm DFB	Standard	16dB	LC	YES

Note1: Standard version.

Product Certificate	Certificate Number	Applicable Standard
		EN 60950-1:2006+A11+A1+A12
TUV	R50135086	EN 60825-1:2007
		EN 60825-2:2004+A1+A2
1.11	F947997	UL 60950-1
UL	E317337	CSA C22.2 No. 60950-1-07
EMC CE		EN 55022:2010
	AE 50285865 0001	EN 55024:2010
<u>CD</u>		IEC 60825-1
СВ	JPTUV-049251	IEC 60950-1
FCC	WTF14F0514437E	47 CFR PART 15 OCT., 2013
FDA	1331340-000	CDRH 1040.10
ROHS	RHS01G006464	2011/65/EU

Regulatory Compliance*Note2

Note2: The above certificate number updated to June 2014, because some certificate will be updated every year, such as FCC, FDA and ROHS. For the latest certification information, please check with Data Controls Inc.

Product Description

The JB1270-XFP-LC.S40 single mode transceiver is small form factor pluggable module for duplex optical data communications such as 10GBASE-ER/EW defined by IEEE 802.3ae and 10G Fiber Channel 1200-SM-LL-L. It is with the XFP 30-pin connector to allow hot plug capability.

The JB1270-XFP-LC.S40 module is designed for single mode fiber and operates at a nominal wavelength of 1270nm. The transmitter section uses a multiple quantum well DFB, which is class 1 laser compliant according to International Safety Standard IEC-60825.

The receiver section uses an integrated InGaAs detector preamplifier (IDP) mounted in an optical header and a limiting post-amplifier IC.

Absolute Maximum Ratings*Note3

Parameter	Symbol	Min	Max	Unit
Maximum Supply Voltage	Vcc	-0.5	4.0	V
Storage Temperature	Ts	-40	85	°C

*Note3: Exceeding any one of these values may destroy the device permanently.

Recommend operating condition

Parameter	Symbol	Min	Тур	Max	Units
Case Operating Temperature	Тс	0	-	70	°C
Power Supply Current	lcc	-	-	580	mA
Supply Voltage	Vcc	3.13	-	3.45	V

Electrical Characteristics

Parameter	Symbol	Min	Тур	Max	Unit			
Transmitter								
Data Rate		9.95	-	11.3	Gbps			
Input differential impedance	Rin	90	100	110	Ω			
Differential data input swing*Note4	Vin,pp	120	-	820	mV			
Transmit Disable Voltage	VD	2.0	-	Vcc	V			
Transmit Enable Voltage	VEN	GND	-	GND+ 0.8	V			
Transmit Disable Assert Time		-	-	10	us			
	Rece	iver						
Differential data output swing*Note4	Vout,pp	340	650	850	mV			
Output Differential Impedance	Pin	90	100	110	Ω			
Data output rise time* ^{Note5}	tr	-	-	38	ps			
Data output fall time* ^{Note5}	tf	-	-	38	ps			
LOS Fault	V _{LOS fault}	2.4	-	Vcc	V			
LOS Normal	VLOS norm	GND	-	GND+0.5	V			

*Note4. Internal AC coupling.

*Note5. 20 - 80 %.

Optical Characteristics

Parameter	Symbol	Min.	Typical	Max.	Unit
Power budget		16			dB
Data Rate		9.95	-	11.3	Gbps
Tra	nsmitter				
Centre Wavelength	λc	1260	1270	1280	nm
Spectral Width (-20dB)	Δλ			1	nm
Side Mode Suppression Ratio	SMSR	30			dB
Average Output Power ^{*note6}	Pout, AVG	1		5	dBm
Extinction Ratio	ER	3.5			dB
Average Power of OFF Transmitter				-30	dBm
Relative Intensity Noise	RIN			-128	dB/Hz
TX Disable Assert Time	t_off			10	us
Re	eceiver				
Centre Wavelength	λc	1320		1340	nm
Sensitivity ^{*note7}	Pin			-15	dBm
Receiver Overload	Рмах	0.5			dBm



XFP BIDI Series

LOS De-Assert	LOSD		-17	dBm
LOS Assert	LOSA	-29		dBm

*Note6. Output is coupled into a 9/125um SMF.

*Note7: Measured with a PRBS 2³¹-1 test pattern @10.3125Gbps.

Pin Descriptions

Pin	Logic	Symbol	Name/Description	Ref.
1		GND	Module Ground	1
2		VEE5	Optional –5.2 Power Supply – Not required	
3	LVTTL-I	Mod-Desel	Module De-select; When held low allows the module	
3		Mod-Desei	to , respond to 2-wire serial interface commands	
			Interrupt (bar); Indicates presence of an important	
4	LVTTL-O	Interrupt	condition which can be read over the serial 2-wire	2
			interface	
5	LVTTL-I	TX_DIS	Transmitter Disable; Transmitter laser source turned	
5		17_013	off	
6		VCC5	+5 Power Supply, Not required	
7		GND	Module Ground	1
8		VCC3	+3.3V Power Supply	
9		VCC3	+3.3V Power Supply	
10	LVTTL-I	SCL	Serial 2-wire interface clock line	2
11	LVTTL- I/O	SDA	Serial 2-wire interface data line	2
		Mod_Abs	Module Absent; Indicates module is not present.	
12	LVTTL-O		Grounded in the module.	2
13	LVTTL-O	Mod NR	Module Not Ready;	2
14	LVTTL-O	 RX LOS	Receiver Loss of Signal indicator	2
15		 GND	Module Ground	1
16		GND	Module Ground	1
17	CML-O	RD-	Receiver inverted data output	
18	CML-O	RD+	Receiver non-inverted data output	
19		GND	Module Ground	1
20		VCC2	+1.8V Power Supply – Not required	
			Power Down; When high, places the module in the	
			low power stand-by mode and on the falling edge	
		D D (D O T	of P Down initiates a module reset	
21	LVTTL-I	P_Down/RST	Reset; The falling edge initiates a complete reset of	
			the module including the 2-wire serial interface,	
			equivalent to a power cycle.	
22		VCC2	+1.8V Power Supply – Not required	
23		GND	Module Ground	1
24		DefCLIC	Reference Clock non-inverted input, AC coupled on	0
24 PECL-I	PECL-I	RefCLK+	the host board – Not required	3



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25	PECL-I	RefCLK-	Reference Clock inverted input, AC coupled on the	3
			host board – Not required	
26		GND	Module Ground	1
27		GND	Module Ground	1
28	CML-I	TD-	Transmitter inverted data input	
29	CML-I	TD+	Transmitter non-inverted data input	
30		GND	Module Ground	1

Notes:

- 1. Module circuit ground is isolated from module chassis ground within the module.
- Open collector; should be pulled up with 4.7k 10k ohms on host board to a voltage between 3.15Vand 3.6V.
- 3. A Reference Clock input is not required.



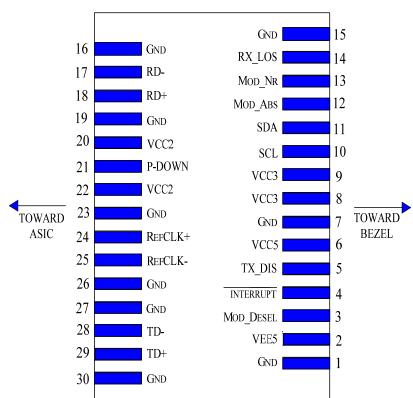


Diagram of Host Board Connector Block Pin Numbers and Name

Digital Diagnostic Functions

JB1270-XFP-LC.S40 Small Form Factor 10Gb/s (XFP) transceivers are compliant with the current XFP Multi-Source Agreement (MSA) Specification Rev 4.5.

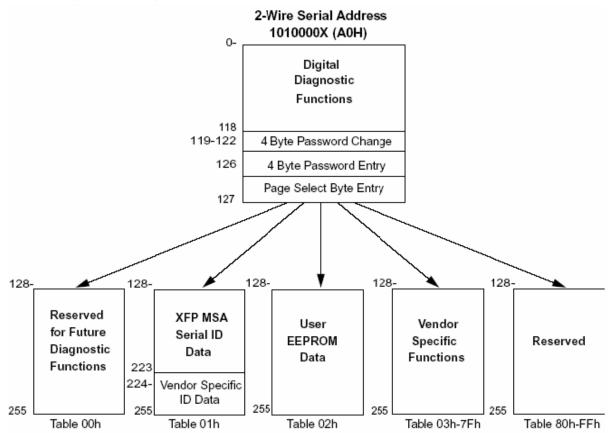
As defined by the XFP MSA, Data Controls Inc XFP transceivers provide digital diagnostic functions via a 2-wire serial interface, which allows real-time access to the following operating parameters:

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- Transceiver temperature
- Laser bias current
- Transmitted optical power
- Received optical power
- Transceiver supply voltage

The structure of the memory map is shown in the following figure, which is accessible over a 2-wire serial interface at the 8-bit address 1010000X (A0h). The normal 256 byte I²C address space is divided into low and upper blocks of 128 Bytes. The lower block of 128 Bytes is always directly available and is used for the diagnostics and control function. Multiple blocks of memories are available in the upper 128 Bytes of the address space. These are individually addressed through a table select Byte which the user enters into a location in the lower address space. Thus, there is a total available address space of 128*256 = 32 Kbytes in this upper memory space. The contents of Table 01h are listed in following table. Please refer SFF INF-8077i (Revision 4.5) for detailed information.



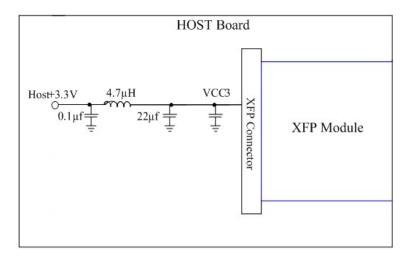
Monitor Specification:

Data Address	Parameter	Accuracy
96 ~ 97	Temperature	± 3℃
98 ~ 99	Reserved	
100~101	Tx Bias	±10%
102~103	Tx Power	±2dB
104~105	Rx Power	± 2dB
106~107	VCC3	± 3%

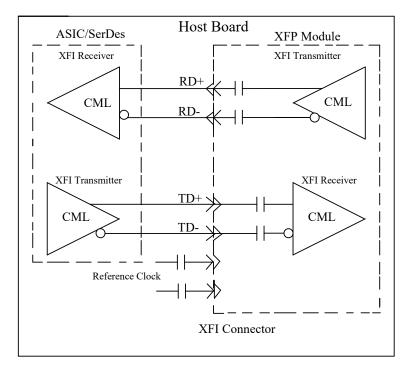
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Recommended Host Board Power Supply Circuit



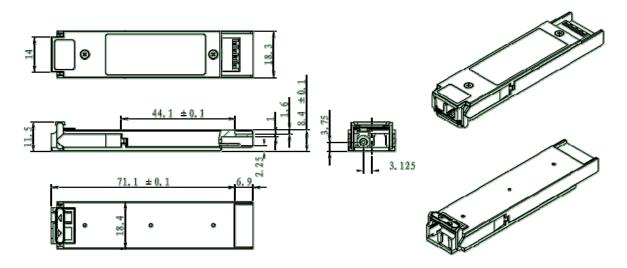
Recommended High-speed Interface Circuit





Mechanical Specifications

Data Controls Inc's XFP transceivers are compliant with the dimensions defined by the XFP Multi-Sourcing Agreement (MSA).



Eye Safety

This single-mode transceiver is a Class 1 laser product. It complies with IEC-60825 and FDA 21 CFR 1040.10 and 1040.11. The transceiver must be operated within the specified temperature and voltage limits. The optical ports of the module shall be terminated with an optical connector or with a dust plug.

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